

# FDH/FDLL 400





COLOR BAND MARKING **DEVICE** 1ST BAND 2ND BAND FDLL400 **BROWN** VIOLET

THE PLACEMENT OF THE EXPANSION GAP HAS NO RELATIONSHIP TO THE LOCATION OF THE CATHODE TERMINAL

# **High Voltage General Purpose Diode**

Sourced from Process 1J. See MMBD1401-1405 for characteristics.

## **Absolute Maximum Ratings\***

TA = 25°C unless otherwise noted

Symbol	Parameter		Value	Units	
W <sub>IV</sub>	Working Inverse Voltage	DH/FDLL400	150	V	
Io	Average Rectified Current		200	mA	
IF	DC Forward Current		500	mA	
İf	Recurrent Peak Forward Current		600	mA	
İf(surge)	Peak Forward Surge Current Pulse width = 1.0 second Pulse width = 1.0 microsecond		1.0 4.0	A A	
T <sub>stg</sub>	Storage Temperature Range		-65 to +200	°C	
TJ	Operating Junction Temperature		175	°C	

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 200 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

# **Thermal Characteristics**

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		FDH/FDLL 400	
P <sub>D</sub>	Total Device Dissipation	500	mW
	Derate above 25°C	3.33	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	°C/W

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# High Voltage General Purpose Diode (continued)

# **Electrical Characteristics**

TA = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
B <sub>V</sub>	Breakdown Voltage FDH/FDLL400	I <sub>R</sub> = 100 μA	200		V
I <sub>R</sub>	Reverse Current FDH/FDLL400	V <sub>R</sub> = 150 V		100	nA
		$V_R = 150 \text{ V}, T_A = 150^{\circ}\text{C}$		100	μΑ
V <sub>F</sub>	Forward Voltage FDH/FDLL400	I <sub>F</sub> = 200 mA		1.0	V
		$I_F = 300 \text{ mA}$		1.1	V
Co	Diode Capacitance FDH/FDLL400	$V_R = 0, f = 1.0 \text{ MHz}$		2.0	pF
T <sub>RR</sub>	Reverse Recovery Time	$I_F = I_R = 30 \text{ mA}, I_{rr} = 3.0 \text{ mA},$		50	nS
	FDH/FDLL400	$R_L = 100 \Omega$			

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